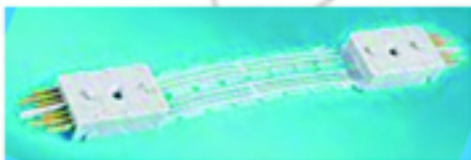


A never-ending chain reaction of people, ideas and technologies

May 3, 1961 — 3Mer Robert Elm files patent for what would become the 3M™ Scotchflex® Cable and Connector System, the first mass-termination interconnect system for electronics.



May 5, 1961 — NASA launches first American into space.



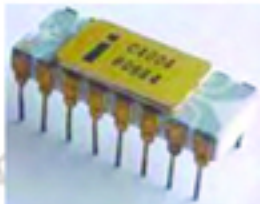
1966 — 3Mer Al Wedekind files patent for a connector that can terminate up to 64 wires at once. In the coming years, computer industry pioneers embrace this new method of wiring.



1969 — NASA lands first human on the moon.



1971 — Intel introduces first single-chip microprocessor.



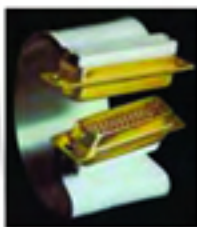
1973 — 3M™ Color Coded Flat Cable introduced for quicker identification of wires, speeding up computer assembly.



1976 — Apple I released.



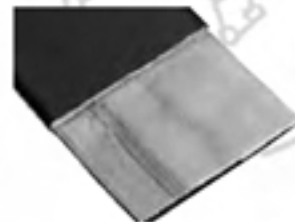
1977 — 3M™ Scotchflex® Delta Connector System released, the first IDC interconnect solution for input/output applications.



1981 — IBM PC launched.



1981 — 3M™ Scotchflex® Shielded Jacket for external cables launched in anticipation of 1983 FCC regulation of electromagnetic interference (EMI) emissions from PCs.



1984 — Apple introduces Macintosh.

1983 — Microsoft unveils Windows.

1986 — 3M™ Mini Delta Ribbon Cable and Connector System released, offering higher-density connections along with protection from EMI emissions.



1990 — 3M™ Mini Socket and Header System released, enabling computer manufacturers to achieve higher density.



1999 — The nonprofit Wi-Fi Alliance forms to establish and enforce standards for wireless devices.



2005 — 3M introduces RoHS-compliant interconnect products in anticipation of European Union environmental directive.



2011 — 3M™ Twin Axial High-Performance Cable becomes available to customers. The culmination of 50 years of 3M interconnect technology, the foldable cable further enables computer manufacturers to produce compact, high-performing products.

